IPC ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
upplier Informa	ation								,			,		
Company name*			Company unique ID			J	Unique ID Authority				Response Date*			
onsemi											2024-04-17			
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Authorized Representative*			Title - Representative			I	Phone - Representative*			Email - Representative*				
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com			
Requester	Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Date Version Manufacturing Site		W	eight*	UOM	Unit Type	
		MC74VH	IC1GT32DFT	LOG GATE LEVE	L SHIFTER		2024-04-17		C	CN1	6.	19	mg	Each
	Proccess Informatio													
2 2		Terminal Base Alloy J-STD-020 MS		_ Rating						er of Reflow Cyc	eles			
PbSn		C	U Alloy	1			235		C	30	seconds	3		
omments														
	me at peak temperature													
or more information	n regarding material cor	nposition p	olease refer to	page 3										

RoHS Material Composition Declaration			Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		oy mass (100 PPM) in homogeneous material for Ca (Cr6+), Polybrominated Biphenyls (PBB), Polybro Diisobutyl phthalate (DIBP).							
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cert as of the date that Supplier completes this for Company acknowledges that Supplier may haindependently verified information provided certification in this paragraph. If the Company that agreement, will be the sole and exclusive	tted biphenyls and/or polybrominated diphenyls of an applicable quantity limit, please indicat ifies that it gathered the information it provide m.Supplier acknowledges that Company will rave relied on informationprovided by others in by others, Supplier agrees that, at a minimum, and the Supplier enter into a written agreement	2011/65/EU and implemented by the laws of the Eu ethers (each a "RoHS restricted substance") in exceed below which, if any, RoHS exemption you believ is in this form using appropriate methods to ensure it ely on this certification in determining the compliant completing this form, and that Supplier may not ha its suppliers have provided certifications regarding to the with respect to the identified part, the terms and company's remedies for issues that arise regarding informable to such part shall apply.	ess of the applicable quantity limit identified able may apply. If the part is an assembly with low to accuracy and that such information is true and acce of its products with European Union membe we independently verified such information. How heir contributions to the part, and those certifical conditions of that agreement, including any warrangement.	ove. If a homogeneous material within the part er level components, the declaration shall a correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 2 - Item(s	s) contains RoHS restricted substances above the	he limits per the definition and is not under exempti	on Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
applicable exemptions.	-		ous, men select the corresponding response r	ii the Rohs Declaration above and choose an					
	EL-2011/534/EU		one, men occes de corresponding responde	ii the Koris Deciaration above and choose an					
applicable exemptions. Exemption List Version Declaration Signature			, ,						
applicable exemptions. Exemption List Version Declaration Signature	fields on all pages of this form. Select the ''A	accepted" on the Supplier Acceptance drop-dow	, ,						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.19	mg	Supplier	Silicon (Si)	7440-21-3		0.19	mg
Lead Frame	2.04	mg	В	Nickel (Ni)	7440-02-0		0.7813	mg
			Supplier	Iron (Fe)	7439-89-6		1.0792	mg
			Supplier	Copper (Cu)	7440-50-8		0.1795	mg
Mold Compound-Black	3.9	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.39	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0195	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.5655	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		2.535	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.39	mg
Plating	0.05	mg	A	Lead (Pb)	7439-92-1		0.01	mg
			Supplier	Tin (Sn)	7440-31-5		0.04	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg